

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L22	700285	(tie or tied or tying or fasten\$4 or bolt\$4 or rivet\$4 or screw\$4 or plug or pin) and (press\$4 or force or load) and heat\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 13:58
L23	643583	22 and (fasten\$4 or bolt\$4 or rivet\$4 or screw\$4 or pin or plug)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:00
L24	45488	23 and (fasten\$4 or bolt\$4 or rivet\$4 or screw\$4 or pin or plug) near ((press\$4 or force or load) or heat\$4 or rotati\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:05
L25	181	24 and (fasten\$4 or bolt\$4 or rivet\$4 or screw\$4 or pin or plug) near (alloy or intermetallic or TiAl or NiAl or FeAl or (ti or ni or fe or titanium or nickel or iron) near (al or aluminum))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:08
L26	16	25 and electrode\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:10
L27	100	25 and (foil or film or layer or solder\$4 or braz\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:11
L28	38	27 and (solder\$4 or braz\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:12
L29	33	25 and rivet\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/01/05 14:13

Searching PAJ

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If you want to conduct a Number Search, please click on the button to the right.

Number Search**Applicant,Title of invention,Abstract --- e.g. computer semiconductor**

If you use the AND/OR operation, please leave a SPACE between keywords.

One letter word or Stopwords are not searchable.

bolt rivet fastener

OR**AND**

pressure heat

AND**AND**

bond join solder

OR**AND****Date of publication of application --- e.g.19980401 - 19980405**

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AND**IPC --- e.g. D01B7/04 A01C11/02**

If you use the OR operation, please leave a SPACE between keywords.

Search**Stored data**

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